



**DMG1012UW** 

#### N-CHANNEL ENHANCEMENT MODE MOSFET

### Features

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- ESD Protected Up To 2kV
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

### **Mechanical Data**

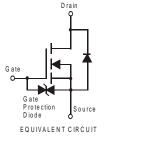
- Case: SOT323
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Alloy 42
  Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.006 grams (Approximate)

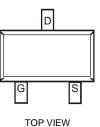


ESD PROTECTED TO 2kV



TOP VIEW





### Ordering Information (Note 4)

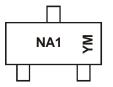
	Part Number	Case	Packaging			
	DMG1012UW-7	SOT323	3000 / Tape & Reel			
Notes:	1 No purposely added lead Fully FLI Directive 2002/05/FC (RoHS) 2011/65/FLI (RoHS 2) & 2015/863/FLI (RoHS 3) compliant					

No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**



NA1 = Product Type Marking Code YM = Date Code Marking Y or  $\overline{Y}$  = Year (ex: G = 2019) M = Month (ex: 9 = September)

Date Co	de Key
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Year	2009	~	20	19	2020	2021	2022	2023	3 20	24	2025	2026
Code	W	~	(	<u> </u>	Н		J	K	l	-	М	Ν
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	Ν	D



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Char	Symbol	Value	Unit		
Drain-Source Voltage	V <sub>DSS</sub>	20	V		
Gate-Source Voltage			V <sub>GSS</sub>	±6	V
Continuous Drain Current (Note 5)	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +85°C	ID	1.0 0.64	А
Pulsed Drain Current (Note 6)	I <sub>DM</sub>	6	A		

# **Thermal Characteristics**

Characteristic	Symbol	Max	Unit
Power Dissipation (Note 5)	PD	0.29	W
Thermal Resistance, Junction to Ambient $@T_A = +25^{\circ}C$ (Note 5)	R <sub>θJA</sub>	425	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

 Device mounted on FR-4 PCB, with minimum recommended pad layout.
 Repetitive rating, pulse width limited by junction temperature. Notes:

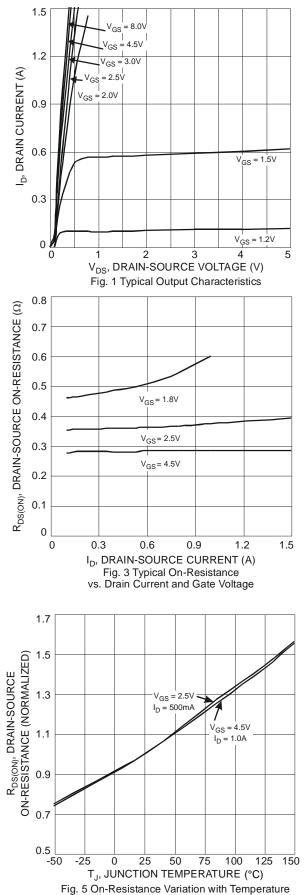
# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

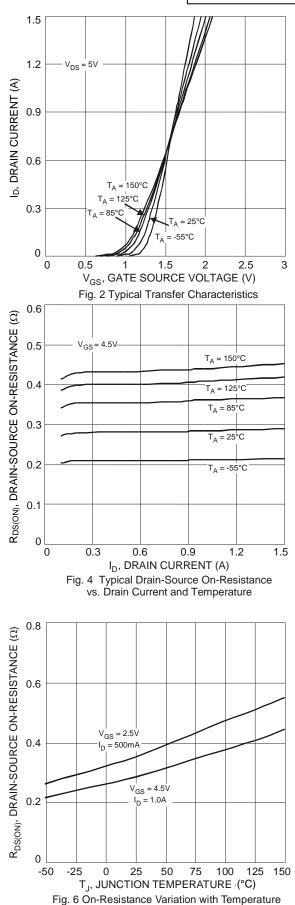
			Ŧ			<b>T</b> ( <b>O</b> 11/1
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)	_					
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	20	-	-	V	$V_{GS} = 0V, I_D = 250 \mu A$
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	I <sub>DSS</sub>	-	-	100	nA	$V_{DS} = 20V, V_{GS} = 0V$
Gate-Source Leakage	I <sub>GSS</sub>	-	-	±1.0	μA	$V_{GS} = \pm 4.5 V, V_{DS} = 0 V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	0.5	-	1.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
		-	0.3	0.45		$V_{GS} = 4.5V, I_D = 600mA$
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>		0.4	0.6	Ω	$V_{GS} = 2.5V, I_D = 500mA$
			0.5	0.75		$V_{GS} = 1.8V, I_D = 350mA$
Forward Transfer Admittance	Y <sub>fs</sub>	-	1.4	-	S	$V_{DS} = 10V, I_D = 400mA$
Diode Forward Voltage	V <sub>SD</sub>	-	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 150mA$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	-	60.67	-	pF	
Output Capacitance	Coss	-	9.68	-	pF	$V_{DS} = 16V, V_{GS} = 0V,$ - f = 1.0MHz
Reverse Transfer Capacitance	C <sub>rss</sub>	-	5.37	-	pF	
Total Gate Charge	Qg	-	736.6	-	рС	
Gate-Source Charge	Q <sub>gs</sub>	-	93.6	-	рС	$V_{GS} = 4.5V, V_{DS} = 10V,$
Gate-Drain Charge	Q <sub>gd</sub>	-	116.6	-	рС	$I_D = 250 \text{mA}$
Turn-On Delay Time	t <sub>D(ON)</sub>	-	5.1	-	ns	
Turn-On Rise Time	t <sub>R</sub>	-	7.4	-	ns	$-V_{DD} = 10V, V_{GS} = 4.5V,$ $-R_1 = 47\Omega, R_G = 10\Omega,$
Turn-Off Delay Time	t <sub>D(OFF)</sub>	-	26.7	-	ns	$-R_{L} = 47\Omega$ , $R_{G} = 10\Omega$ , $-I_{D} = 200 \text{mA}$
Turn-Off Fall Time	t <sub>F</sub>	-	12.3	-	ns	

 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to production testing. Notes:

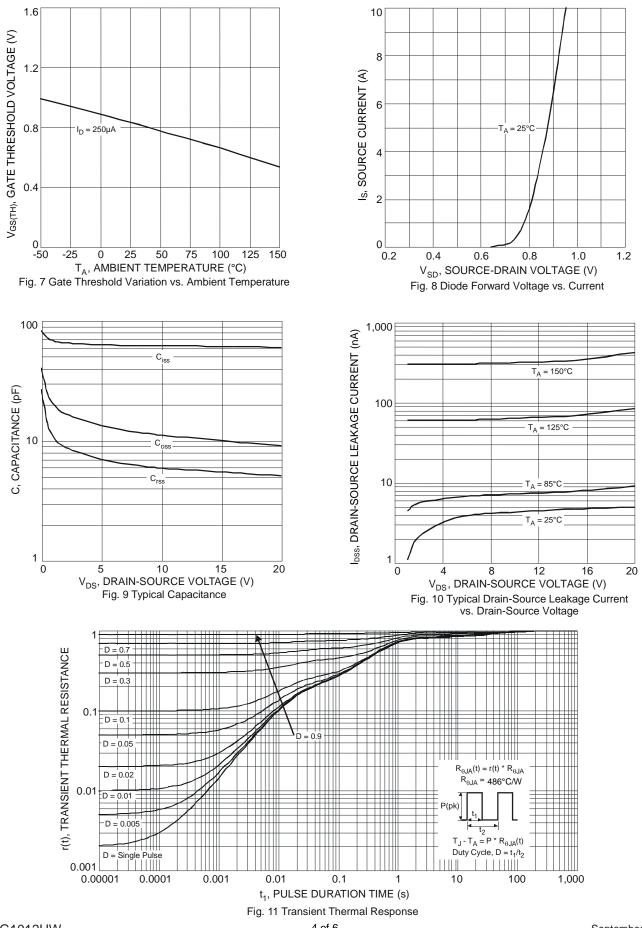












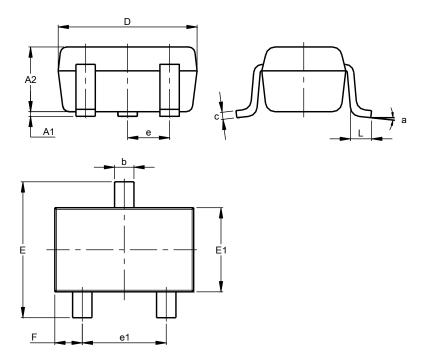
DMG1012UW Document number: DS31859 Rev. 5 - 2

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# **Package Outline Dimensions**

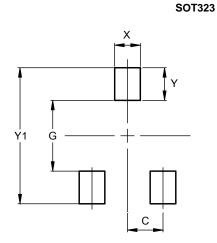
Please see http://www.diodes.com/package-outlines.html for the latest version.



	SOT323								
Dim	Min	Max	Тур						
A1	0.00	0.10	0.05						
A2	0.90	1.00	0.95						
b	0.25	0.40	0.30						
С	0.10	0.18	0.11						
D	1.80	2.20	2.15						
Е	2.00	2.20	2.10						
E1	1.15	1.35	1.30						
е	C	).650 B	SC						
e1	1.20	1.40	1.30						
F	0.375	0.475	0.425						
L	0.25	0.40	0.30						
а	0°	8°							
All Dimensions in mm									

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)			
С	0.650			
G	1.300			
Х	0.470			
Y	0.600			
Y1	2.500			

DMO40401W4



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